Mini*PIX<sub>EDU</sub>* Miniaturized and low power radiation camera





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#### **General features**

The MiniPIX <sub>EDU</sub> is miniaturized and low power solution of radiation camera with single particle counting (or particle tracking) detector Timepix. The standard MiniPIX <sub>EDU</sub> system incorporates single Timepix detector (256 x 256 pixels with pitch of 55  $\mu$ m) with 300 or 500  $\mu$ m thick silicon. It uses USB 2.0 interface capable of reading up to 45 frames per second (with exposure time of 1 ms). The Timepix detector is energy sensitive which brings a new dimension to radiographic images. The device can also visualize many kinds of ionizing radiation particles (beta, alpha, cosmic radiation, etc.). The

Main features					
Readout chip type	Timepix				
Pixel size <sup>1</sup>	55 x 55 μm				
Sensor resolution	256 x 256 pixels				
Dynamic range in one frame²	11 810				
Sensor material	300 or 500 µm Si				
Dark current	none				
Interface	USB 2.0 (High-Speed)				
Maximum frame rate	45 fps				
Dimensions	88.9 x 21 x 10 mm				
Weight	30 g				
1 55 x 110 μm at the edges and 110 x 110 μm at the corners					
2 Dynamic range of final picture is theoretically unlimited;					

the only limiting factor is exposure time.

**Mini***PIX*<sub>EDU</sub> device is controlled via USB interface. The major operating systems are supported (MS Windows, Mac OS and LINUX).

The **Mini***PIX*<sub>EDU</sub> is an ideal device for physics classes where students can literarily 'see" the radiation surrounding us.



Illustration of single particle sensitivity of Timepix3 device. The tracks of different particles of radiation background (mostly muons and few protons) were recorded in 5 minutes on board of airplane. No noise (clean zero) is seen in dark regions.

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Device parameters							
Operating conditions							
Symbol	Parameter	Value	Units	Comment			
T <sub>a</sub>	Operating ambient temperature range <sup>1</sup>	0-50	°C				
Φ	Humidity	<85	%	Not condensing			
IP	IP rating with cover IP30 3D printed cover supplied with the device						
<sup>1</sup> With temperature stabilization – see the paragraph below.							

### External temperature stabilization

Temperature stabilization of the device is strongly recommended for consistent results. Attaching a Peltier cooling or cooling plate at the back of the detector should serve the purpose. The temperature should be set to 22 °C.



The device will automatically shut down after chip or CPU temperature exceeds 55 °C.

Electrical specification T <sub>def</sub> = 22 °C, USB voltage V <sub>cc</sub> = 4.8V						
Symbol	Parameter	Min	Тур	Max	Units	Comment
V <sub>cc</sub>	Supply Voltage	4.4	5.0	5.25	V	Comply with USB 2.0
I <sub>CC2</sub>	Chip active			500	mA	Comply with USB 2.0
P1	Power Dissipation			2.5	W	
V <sub>BIAS</sub>	Bias Voltage	3		200	V	

Performance characteristics of Timepix							
Symbol	Parameter	Min	Тур	Max	Units	Comment	
f	Frame-rate			45	fps	with USB 2.0 Host	
T <sub>read</sub>	Frame readout time <sup>2</sup>		22		ms		
2 During Readout time (or Dead time), no charge is collected from the sensor.							

#### **Performance limitations**

MiniPIX Four has some minor limitations compared to the standard MiniPIX.

- No sensor stability or pixel response patterns are evaluated.
- Quality of the chip will be evaluated only in the central area (50% of the full sensor area).
- One column of bad pixels is allowed in the central area.
- Bad pixel clusters of up to 20 pixels are allowed (except column).
- Overall, 1 % of bad pixels in the central area (324 pixels) is allowed, including a bad column if any.
- Quality criteria for 300 μm and 500 μm thick Si sensors are the same.
- MiniPIX EDU comes with Pixet Basic software, which has limited functionality compared to Pixet Pro.
- In Pixet Basic in the imaging mode there is a watermark in the bottom left corner the Advacam company logo.





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Sensor parameters T <sub>def</sub> = 25 °C							
Symbol	Parameter	5	Si	Units	Comment		
	Thickness	300	500	μm			
σ	Energy threshold step	0.1		keV			
σ	Energy resolution in full spectral mode (σ @ 23 keV)	1	.9	keV			
σ	Energy resolution in full spectral mode (σ @ 60 keV)	1.8		keV			
	Pixel size <sup>1</sup>	5	5	μm			
<sup>1</sup> 55 x 110 µm at the edges and 110 x 110 µm at the corners							

Modes of readout chip operation				
Туре	Mode	Counter depth	Description	
Frame	Tracking	13bit/frame	1 output image: Sum of all Energies deposited in given pixel in keV	
(reading all pixels)	Imaging	13bit/frame	1 output image: Number of Events per pixel	

## **Device description**



## USB connector

USB type A, Standard USB 2.0 High-Speed.

Certificates						
Mini <i>PIX</i> <sub>EDU</sub> has been tested by certification authority (Electrotechnical testing institute EZÚ) according to following standards:						
Standard number	Name					
EN 61000-6-2:05	Electromagnetic compatibility (EMC) - Immunity standard for industrial environments					
EN 61000-6-4:07+A1:11	Electromagnetic compatibility (EMC) - Emission standard for industrial environments					



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### **Mechanical dimensions**



All dimensions are in mm.

 $^{\ast}$  Sensitive surface distance from top of the box is for 300  $\mu m$  sensor thickness.

Extreme care must be taken when removing protecting cover and handling the Mini $PIX_{EDU}$  without the protecting cover. Warranty does not apply to mechanical damage of the sensor and wirebonds.

## Model number codes (example)

MNX	TXE	Х	Р	3	00210520
Device name MNX – MiniPIX	Device modification TXE – Timepix Edu		Sensor type P-Planar silicon E – Edgeless silicon	Sensor thickness 3 – 300 µm 5 – 500 µm	XXXXXXXX

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#### Instructions for safe use



To avoid malfunction or damage to your Mini*PIX* FOLL please observe the following:

- Do not expose to water or moisture.
- Do not disassemble. Wire-bonding connection may be irreversibly damaged.
- Do not insert any object into the sensor window.
- Maximum USB cable length is 2 m
- The protection provided by this product may be impaired if it is used in a manner not described in this document
- Thermal stabilization of the device is necessary. Recommended temperature is 22 °C.

#### Disposal



Do not dispose these instruments as unsorted municipal waste. Please use separate collection facility to contact the supplier from which the instrument was purchased. Please make sure discarded electrical waste is properly recycled to reduce environment impact.

Release history						
Date	Changes	Changed by				
20/06/10	Mechanical dimensions					
20/08/20	Added Edgeless Sensor					
21/07/09	New version					
22/01/04	EDU parameters update					
24/01/10	EDU – Pixet Basic update	J. Baborák				
24/04/16	Datasheet revision, modes updated, added watermark info	J. Baborák				
24/05/24	New graphic style of the document	J. Baborák, P. Bloudek				
24/06/12	Warning sign change	J. Baborák				

